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Intel® JHL6540 Thunderbolt™ 3 Controller

Specifications Essentials I/O Specifications **Package Specifications**

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Specifications		Related Products
- Essentials		Multi I/O Products
Status	Launched	Multi I/O Controllers
Launch Date	Q2'16	Products formerly Alpine Ridge
Embedded Options Available	No	
TDP	2.2 W	
Recommended Customer Price		
Datasheet	Link	
Conflict Free	Yes	Learn how Intel is pursuing conflict-free technology. >
- I/O Specifications		0.141114
# of Ports	Dual	Quick Links
PCI Express Configurations ‡	Gen 3	Export Full Specifications >
Display Port	1.2	Support Overview > Search Distributors >
Package Specifications		
Package Size	10.7x10.7mm	PCN/MDDS Information
Low Halogen Options Available	See MDDS	PCN/MDDS Information Not Available

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not vet available. Please refer to the Launch Date for market availability

‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

-unit purchase quantities, and are subject to change without The Recommended Customer

notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. If sold in bulk, price represents individual unit. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.





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